Data Sheet No. PD60195-D

International
IOR Rectifier

IR2010(S) & (PbF)

HIGH AND LOW SIDE DRIVER

Features

- Floating channel designed for bootstrap operation
  Fully operational to 200V
  Tolerant to negative transient voltage, dV/dt immune
- Gate drive supply range from 10 to 20V
- Undervoltage lockout for both channels
- 3.3V logic compatible
  Separate logic supply range from 3.3V to 20V
  Logic and power ground ±5V offset
- CMOS Schmitt-triggered inputs with pull-down
- Shut down input turns off both channels
- Matched propagation delay for both channels
- Outputs in phase with inputs
- Also available LEAD-FREE

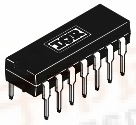
Product Summary

V_{OFFSET}	200V max.
I_O+/-	3.0A / 3.0A typ.
V_{OUT}	10 - 20V
$t_{on/off}$	95 & 65 ns typ.
Delay Matching	15 ns max.

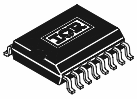
Applications

- Audio Class D amplifiers
- High power DC-DC SMPS converters
- Other high frequency applications

Packages



14-Lead PDIP

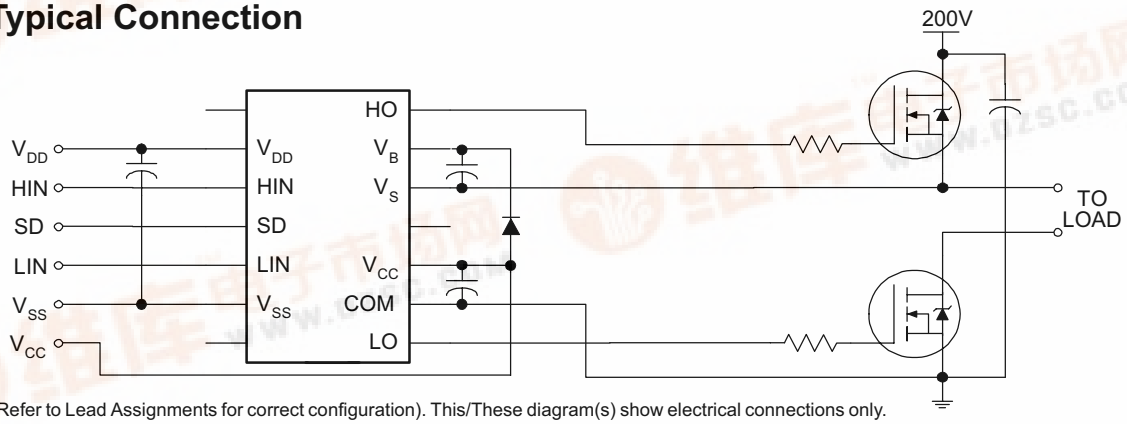


16-Lead SOIC

Description

The IR2010 is a high power, high voltage, high speed power MOSFET and IGBT drivers with independent high and low side referenced output channels, ideal for Audio Class D and DC-DC converter applications. Logic inputs are compatible with standard CMOS or LSTTL output, down to 3.0V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. Propagation delays are matched to simplify use in high frequency applications. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high side configuration which operates up to 200 volts. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction.

Typical Connection



(Refer to Lead Assignments for correct configuration). This/These diagram(s) show electrical connections only.
Please refer to our Application Notes and DesignTips for proper circuit board layout.

Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition		Min.	Max.	Units
V_B	High side floating supply voltage		-0.3	225	V
V_S	High side floating supply offset voltage		V_B - 25	V_B + 0.3	
V_{HO}	High side floating output voltage		V_S - 0.3	V_B + 0.3	
V_{CC}	Low side fixed supply voltage		-0.3	25	
V_{LO}	Low side output voltage		-0.3	V_{CC} + 0.3	
V_{DD}	Logic supply voltage		-0.3	V_{SS} + 25	
V_{SS}	Logic supply offset voltage		V_{CC} - 25	V_{CC} + 0.3	
V_{IN}	Logic input voltage (HIN, LIN & SD)		V_{SS} - 0.3	V_{DD} + 0.3	
dV_s/dt	Allowable offset supply voltage transient (figure 2)		—	50	V/ns
P_D	Package power dissipation @ $T_A \leq +25°C$	(14 lead DIP)	—	1.6	W
		(16 lead SOIC)	—	1.25	
R_{THJA}	Thermal resistance, junction to ambient	(14 lead DIP)	—	75	°C/W
		(16 lead SOIC)	—	100	
T_J	Junction temperature		—	150	°C
T_S	Storage temperature		-55	150	
T_L	Lead temperature (soldering, 10 seconds)		—	300	

Recommended Operating Conditions

The input/output logic timing diagram is shown in figure 1. For proper operation the device should be used within the recommended conditions. The V_S and V_{SS} offset ratings are tested with all supplies biased at 15V differential. Typical ratings at other bias conditions are shown in figures 24 and 25.

Symbol	Definition	Min.	Max.	Units
V_B	High side floating supply absolute voltage	V_S + 10	V_S + 20	V
V_S	High side floating supply offset voltage	Note 1	200	
V_{HO}	High side floating output voltage	V_S	V_B	
V_{CC}	Low side fixed supply voltage	10	20	
V_{LO}	Low side output voltage	0	VCC	
V_{DD}	Logic supply voltage	V_{SS} + 3	V_{SS} + 20	
V_{SS}	Logic supply offset voltage	-5 (Note 2)	5	
V_{IN}	Logic input voltage (HIN, LIN & SD)	V_{SS}	V_{DD}	
T_A	Ambient temperature	-40	125	°C

Note 1: Logic operational for V_S of -4 to +200V. Logic state held for V_S of -4V to $-V_{BS}$.

Note 2: When V_{DD} < 5V, the minimum V_{SS} offset is limited to $-V_{DD}$.

(Please refer to the Design Tip DT97-3 for more details).

Dynamic Electrical Characteristics

V_{BIAS} (V_{CC}, V_{BS}, V_{DD}) = 15V, C_L = 1000 pF, T_A = 25°C and V_{SS} = COM unless otherwise specified. The dynamic electrical characteristics are measured using the test circuit shown in Figure 3.

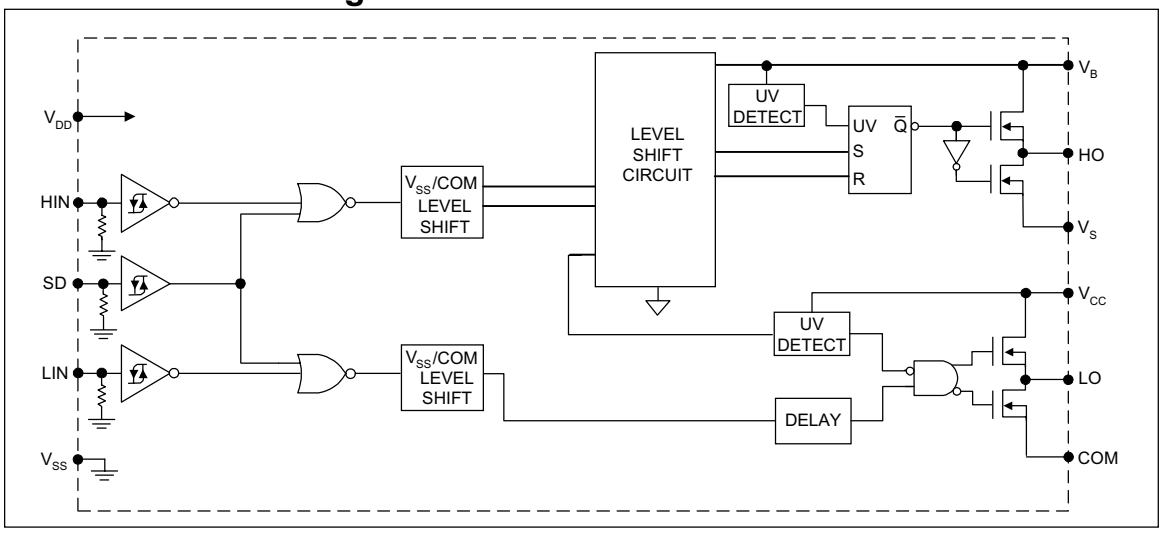
Symbol	Definition	Figure	Min.	Typ.	Max.	Units	Test Conditions
t_{on}	Turn-on propagation delay	7	50	95	135	ns	V_S = 0V
t_{off}	Turn-off propagation delay	8	30	65	105		V_S = 200V
t_{sd}	Shutdown propagation delay	9	35	70	105		V_S = 200V
t_r	Turn-on rise time	10	—	10	20		
t_f	Turn-off fall time	11	—	15	25		
MT	Delay matching, HS & LS turn-on/off	6	—	—	15		

Static Electrical Characteristics

V_{BIAS} (V_{CC}, V_{BS}, V_{DD}) = 15V, T_A = 25°C and V_{SS} = COM unless otherwise specified. The V_{IN}, V_{TH} and I_{IN} parameters are referenced to V_{SS} and are applicable to all three logic input leads: HIN, LIN and SD. The V_O and I_O parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

Symbol	Definition	Figure	Min.	Typ.	Max.	Units	Test Conditions
V_{IH}	Logic “1” input voltage	12	9.5	—	—	V	V_{DD} = 15V
V_{IL}	Logic “0” input voltage	13	—	—	6.0		
V_{IH}	Logic “1” input voltage	12	2	—	—		V_{DD} = 3.3V
V_{IL}	Logic “0” input voltage	13	—	—	1		
V_{OH}	High level output voltage, V_{BIAS} - V_O	14	—	—	1.0		I_O = 0A
V_{OL}	Low level output voltage, V_O	15	—	—	0.1		I_O = 0A
I_{LK}	Offset supply leakage current	16	—	—	50	µA	V_B=V_S = 200V
I_{QBS}	Quiescent V_{BS} supply current	17	—	70	210		V_{IN} = 0V or V_{DD}
I_{QCC}	Quiescent V_{CC} supply current	18	—	100	230		V_{IN} = 0V or V_{DD}
I_{QDD}	Quiescent V_{DD} supply current	19	—	1	5		V_{IN} = 0V or V_{DD}
I_{IN+}	Logic “1” input bias current	20	—	20	40		V_{IN} = V_{DD}
I_{IN-}	Logic “0” input bias current	21	—	—	1.0		V_{IN} = 0V
V_{BSUV+}	V_{BS} supply undervoltage positive going threshold	22	7.5	8.6	9.7	V	
V_{BSUV-}	V_{BS} supply undervoltage negative going threshold	23	7.0	8.2	9.4		
V_{CCUV+}	V_{CC} supply undervoltage positive going threshold	24	7.5	8.6	9.7		
V_{CCUV-}	V_{CC} supply undervoltage negative going threshold	25	7.0	8.2	9.4		
I_{O+}	Output high short circuit pulsed current	26	2.5	3.0	—	A	V_O = 0V, V_{IN} = V_{DD} PW ≤ 10 µs
I_{O-}	Output low short circuit pulsed current	27	2.5	3.0	—		V_O = 15V, V_{IN} = 0V PW ≤ 10 µs

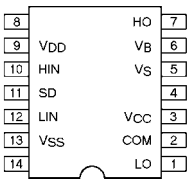
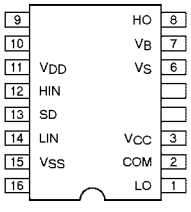
Functional Block Diagram



Lead Definitions

Symbol	Description
V_{DD}	Logic supply
HIN	Logic input for high side gate driver output (HO), in phase
SD	Logic input for shutdown
LIN	Logic input for low side gate driver output (LO), in phase
V_{SS}	Logic ground
V_B	High side floating supply
HO	High side gate drive output
V_S	High side floating supply return
V_{CC}	Low side supply
LO	Low side gate drive output
COM	Low side return

Lead Assignments

	
14 Lead PDIP	16 Lead SOIC (Wide Body)
IR2010	**IR2010S**
Part Number	

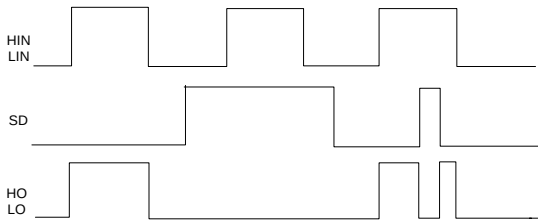


Figure 1. Input/Output Timing Diagram

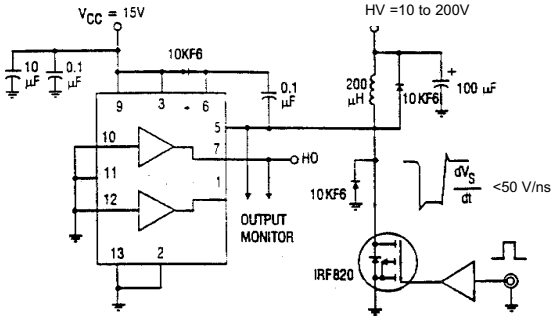


Figure 2. Floating Supply Voltage Transient Test Circuit

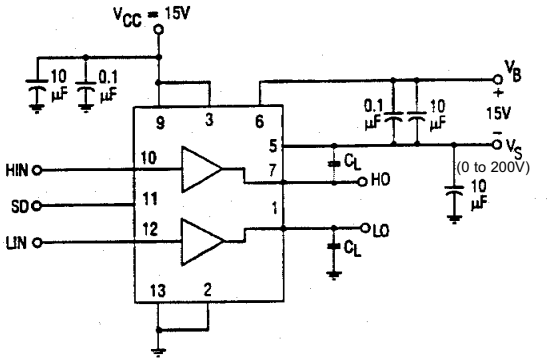


Figure 3. Switching Time Test Circuit

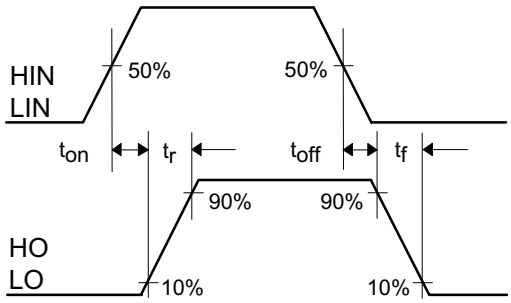


Figure 4. Switching Time Waveform Definition

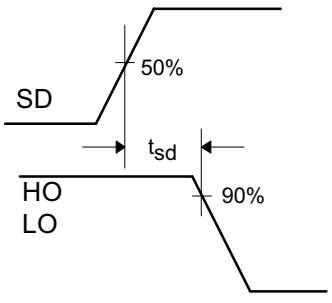


Figure 5. Shutdown Waveform Definitions

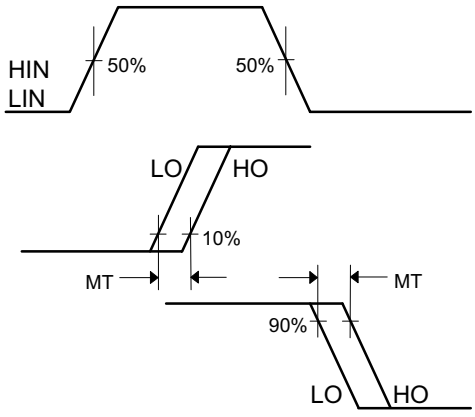


Figure 6. Delay Matching Waveform Definitions

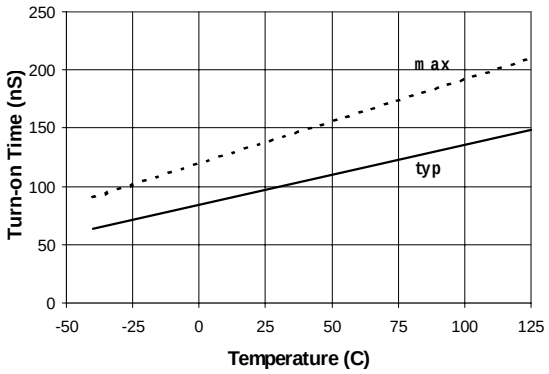


Figure 7A. Turn-on Time vs. Temperature

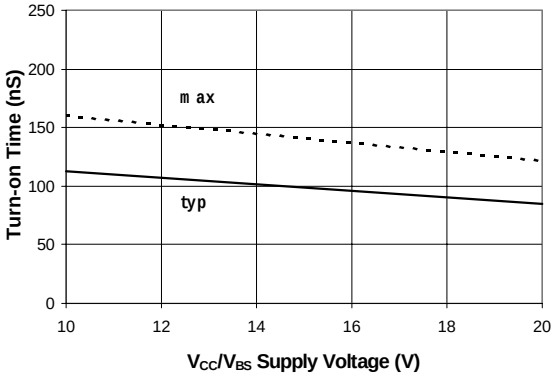


Figure 7B. Turn-on Time vs. V_{CC}/V_{BS} Voltage

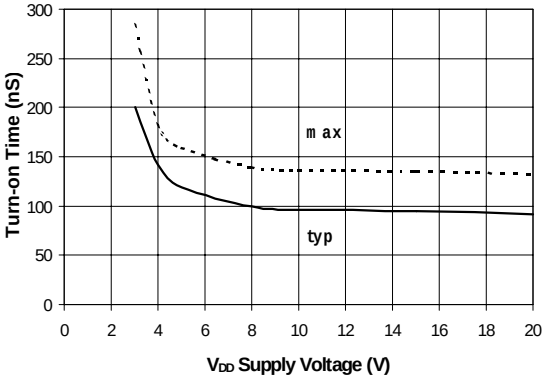


Figure 7C. Turn-on Time vs V_{DD} Voltage

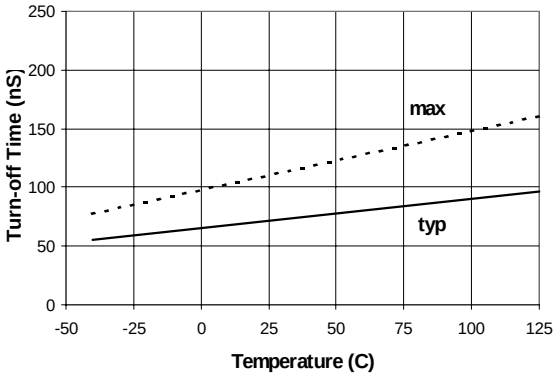


Figure 8A. Turn-off Time vs. Temperature

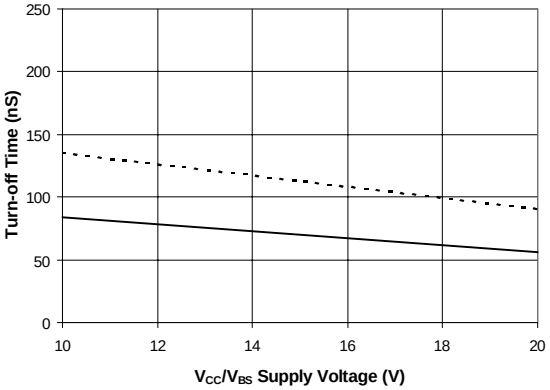


Figure 8B. Turn-off Time vs. V_{CC}/V_{BS} Voltage

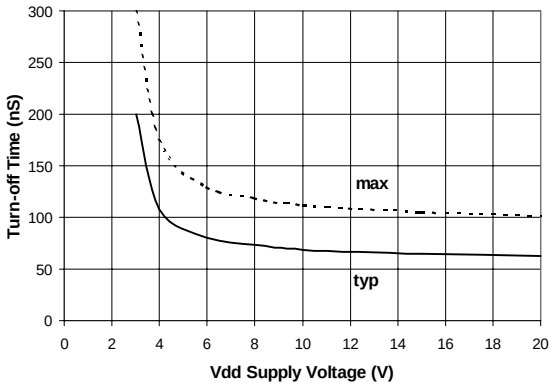


Figure 8C. Turn-off Time vs. V_{DD} Voltage

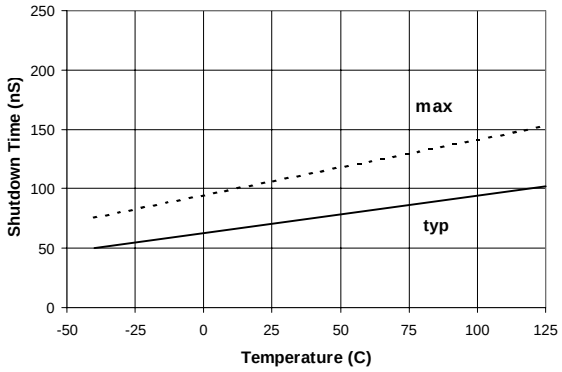


Figure 9A. Shutdown Time vs. Temperature

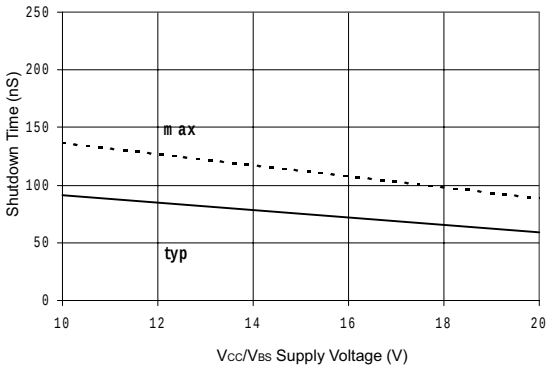


Figure 9B. Shutdown Time vs. V_{CC}/V_{BS}Voltage

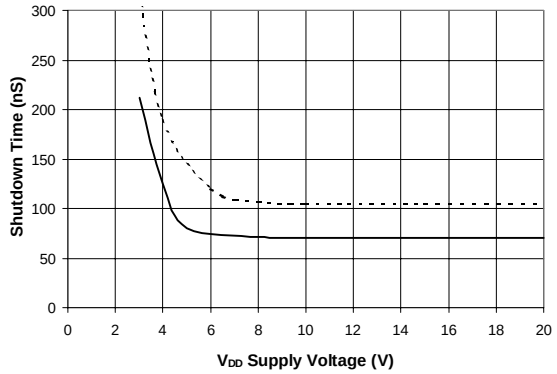


Figure 9C. Shutdown Time vs V_{DD} Voltage

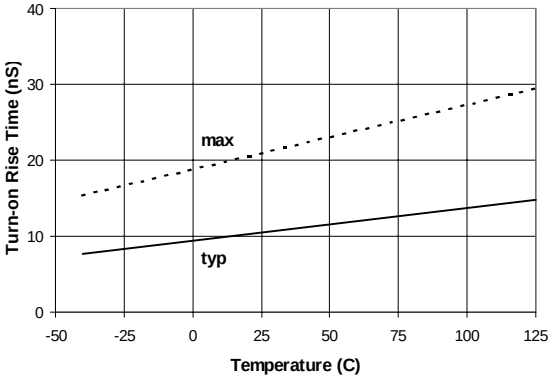


Figure 10A. Turn-on Rise Time vs. Temperature

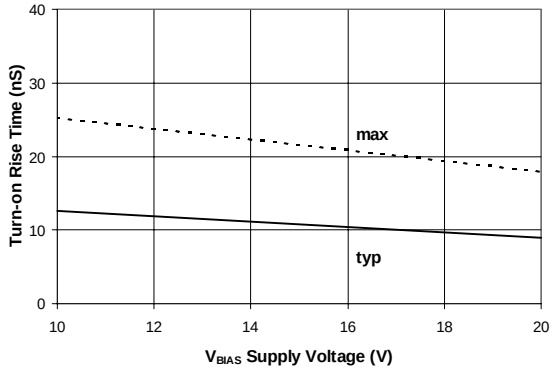


Figure 10B. Turn-on Rise Time vs. V_{BIAS} (V_{CC}=V_{BS}=V_{DD}) Voltage

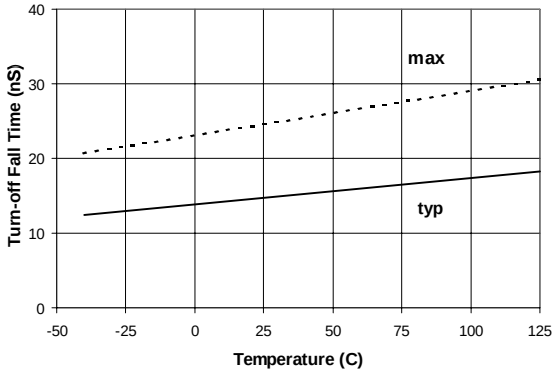


Figure 11A. Turn-off Fall Time vs. Temperature

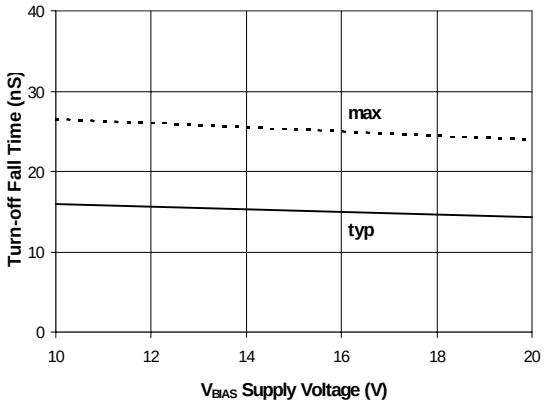


Figure 11B. Turn-Off Fall Time vs. V_{BIAS} (V_{CC}=V_{BS}=V_{DD}) Voltage

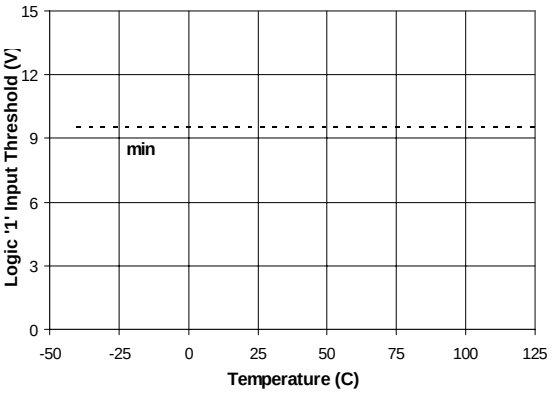


Figure 12A. Logic "1" Input Threshold vs. Temperature

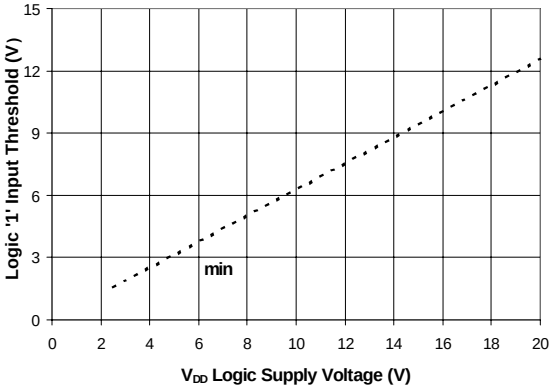


Figure 12B. Logic "1" Input Threshold vs. V_{DD} Voltage

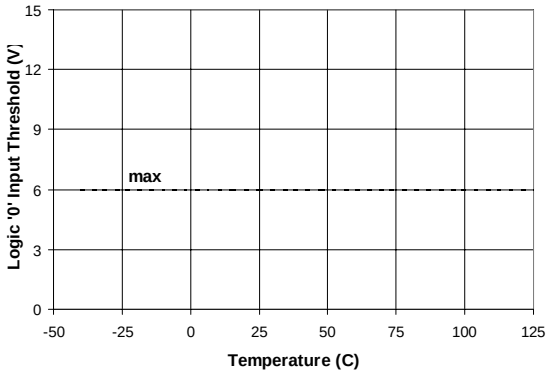


Figure 13A. Logic "0" Input Threshold vs. Temperature

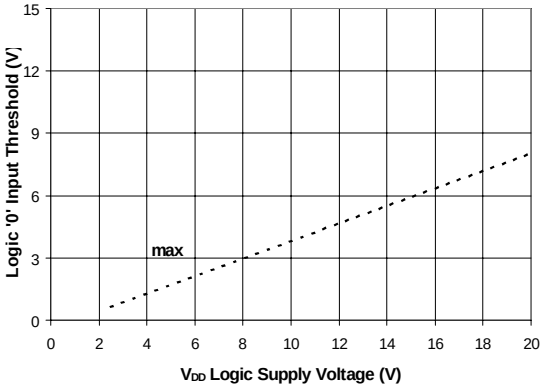


Figure 13B. Logic "0" Input Threshold vs. V_{DD} Voltage

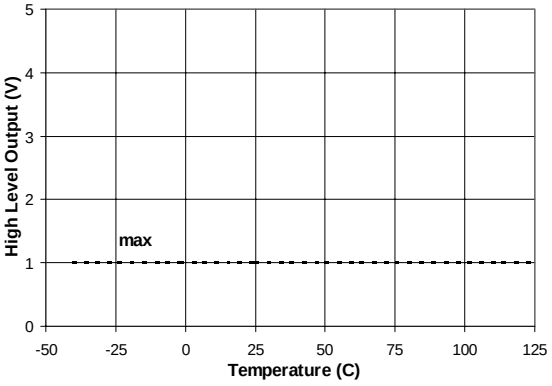


Figure 14A. High Level Output vs. Temperature

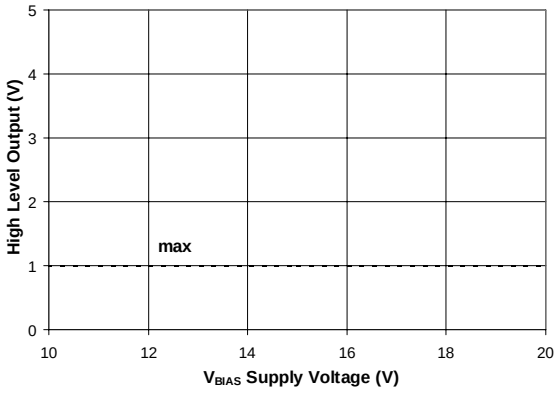


Figure 14B. High Level Output vs. V_{BIAS} Voltage

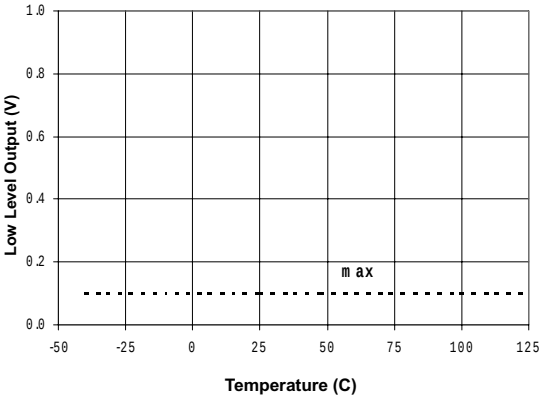


Figure 15A. Low Level Output vs. Temperature

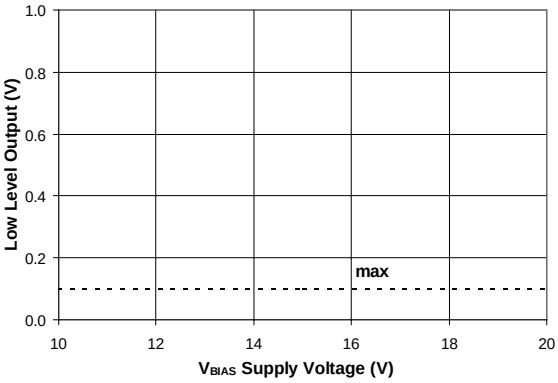


Figure 15B. Low Level Output vs. V_{BIAS} Voltage

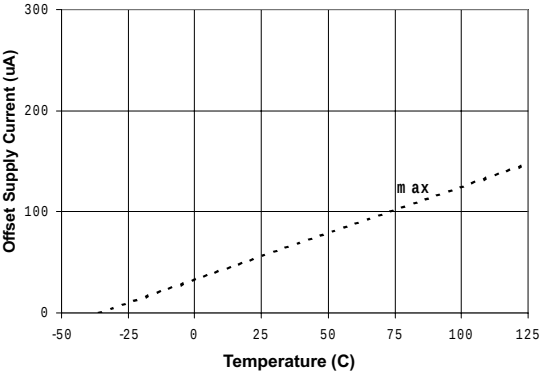


Figure 16A. Offset Supply Current vs. Temperature

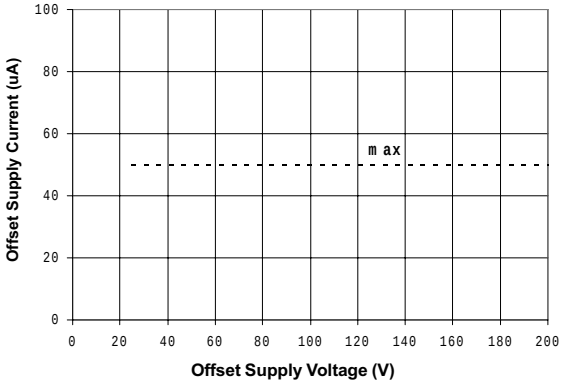


Figure 16B. Offset Supply Current vs. Offset Voltage

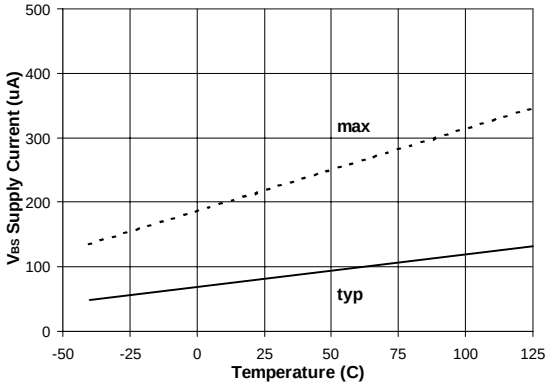


Figure 17A. Vbs Supply Current vs. Temperature

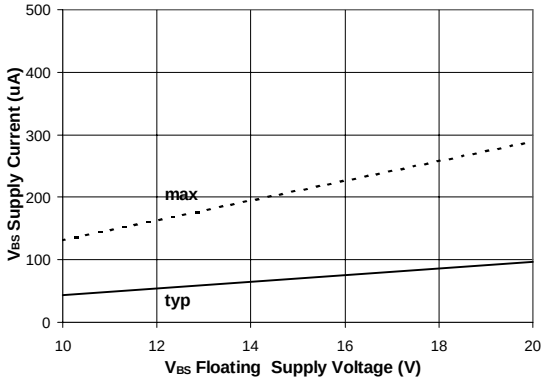


Figure 17B. Vbs Supply Current vs. V_{BS} Voltage

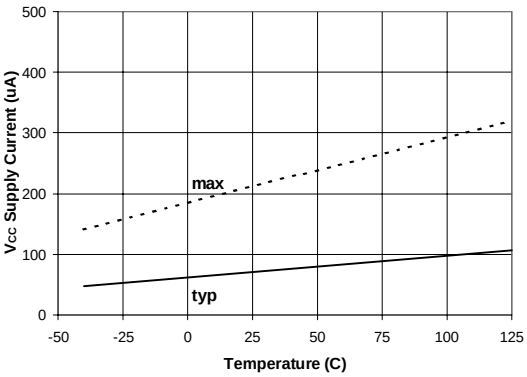


Figure 18A. Vcc Supply Current vs. Temperature

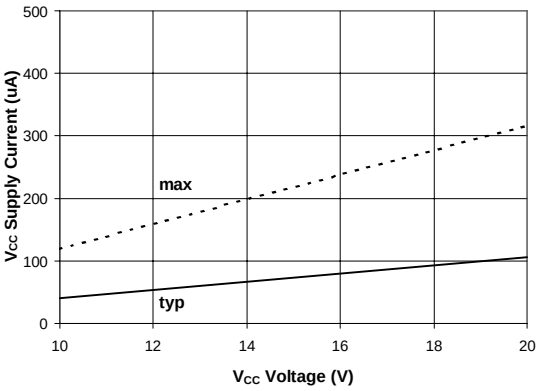


Figure 18B. Vcc Supply Current vs. V_{CC} Voltage

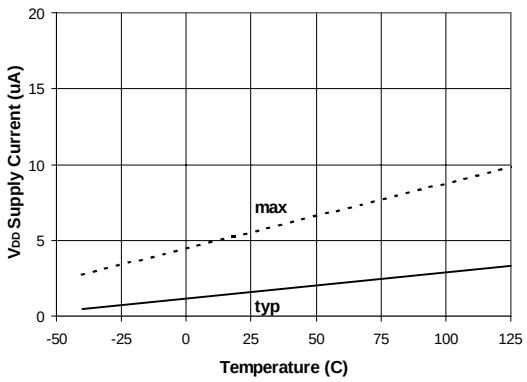


Figure 19A. Vdd Supply Current vs. Temperature

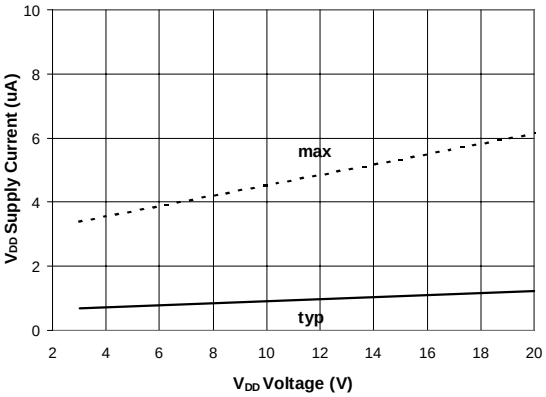


Figure 19B. Vdd Supply Current vs. V_{DD} Voltage

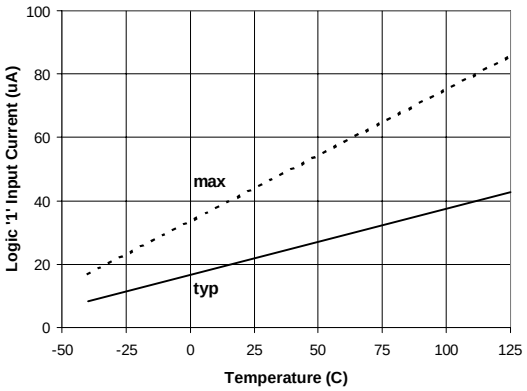


Figure 20A. Logic "1" Input Current vs. Temperature

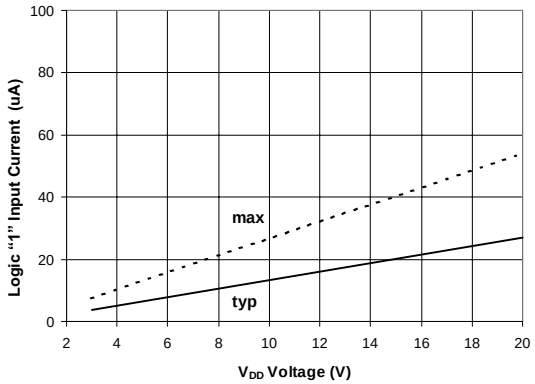


Figure 20B. Logic "1" Input Current vs. V_{DD} Voltage

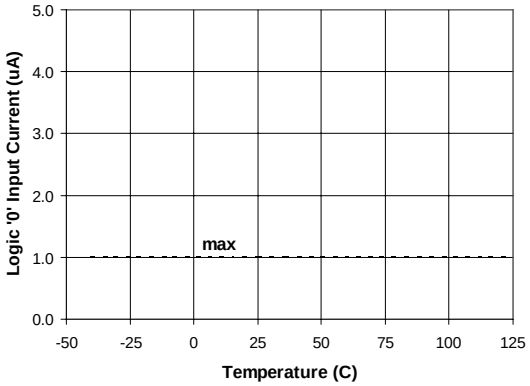


Figure 21A. Logic "0" Input Current vs. Temperature

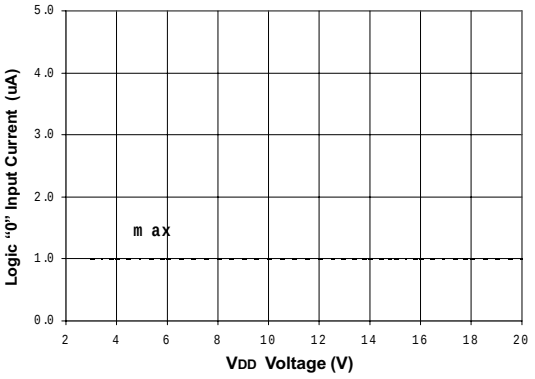


Figure 21B. Logic "0" Input Current vs. V_{DD} Voltage

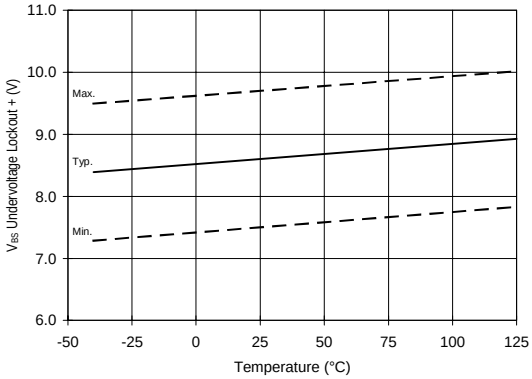


Figure 22. V_{BS} Undervoltage (+) vs. Temperature

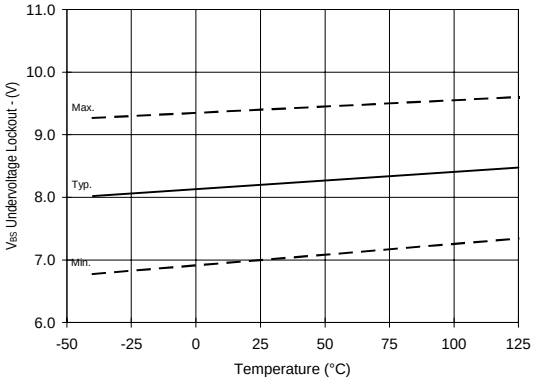


Figure 23. V_{BS} Undervoltage (-) vs. Temperature

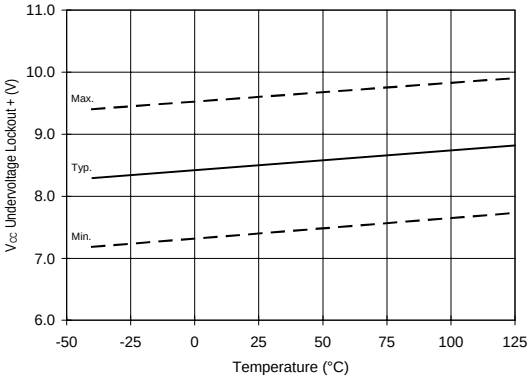


Figure 24. V_{CC} Undervoltage (+) vs. Temperature

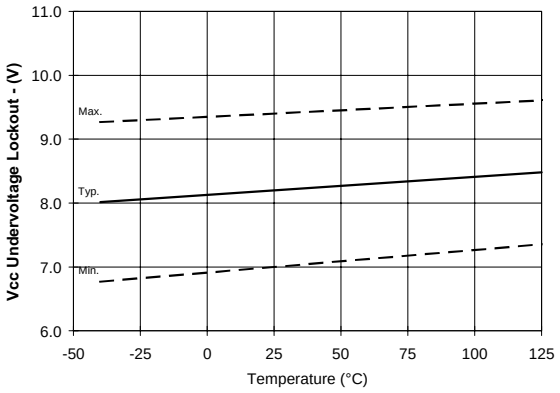


Figure 25. V_{CC} Undervoltage (-) vs. Temperature

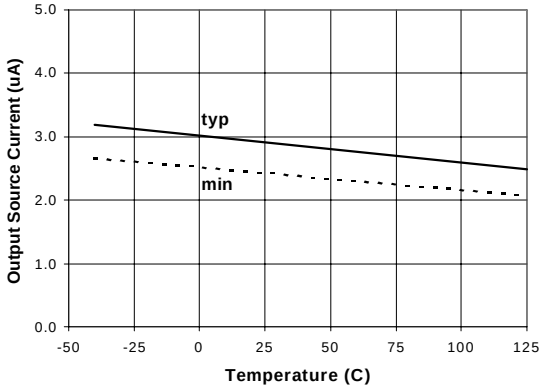


Figure 26A. Output Source Current vs. Temperature

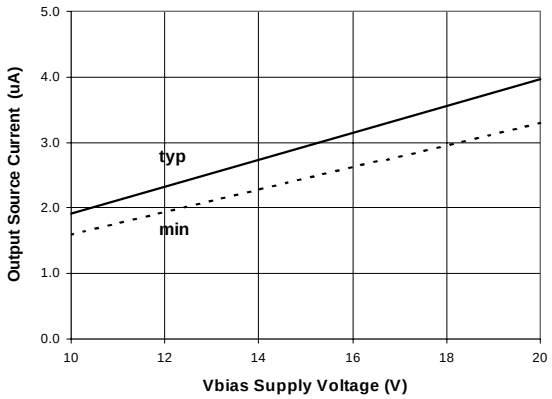


Figure 26B. Output Source Current vs. V_{BIAS} Voltage

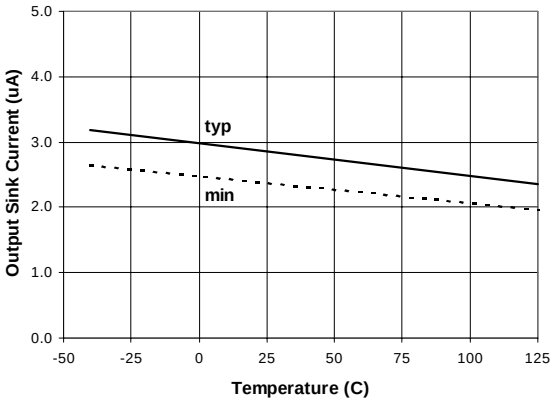


Figure 27A. Output Sink Current vs. Temperature

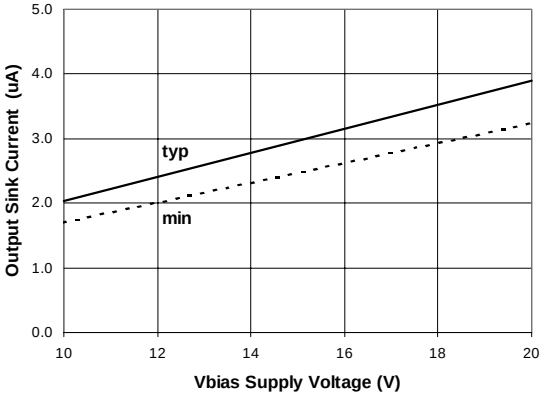


Figure 27B. Output Sink Current vs. V_{BIAS} Voltage

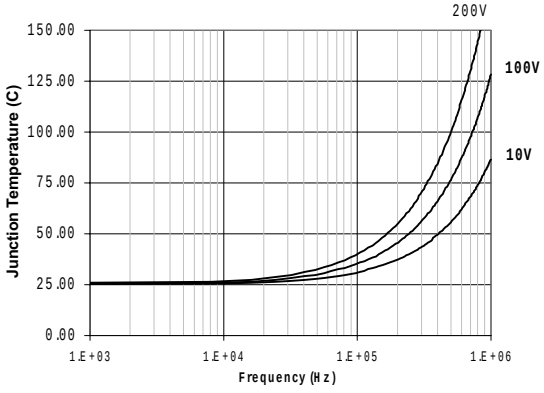


Figure 28. IR2010 Tj vs Frequency
R_{GATE} = 10 Ohm, Vcc = 15V with IRFPE50

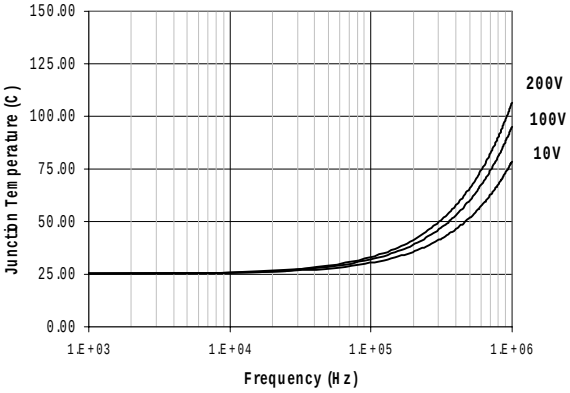


Figure 29. IR2010 Tj vs Frequency
R_{GATE} = 16 Ohm, Vcc = 15V with IRFBC40

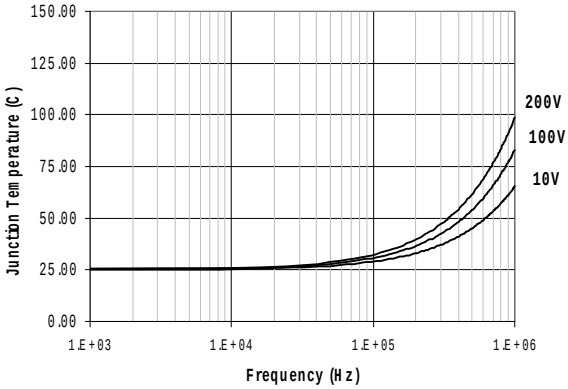


Figure 30. IR2010 Tj vs Frequency
R_{GATE} = 22 Ohm, Vcc = 15V with IRFBC30

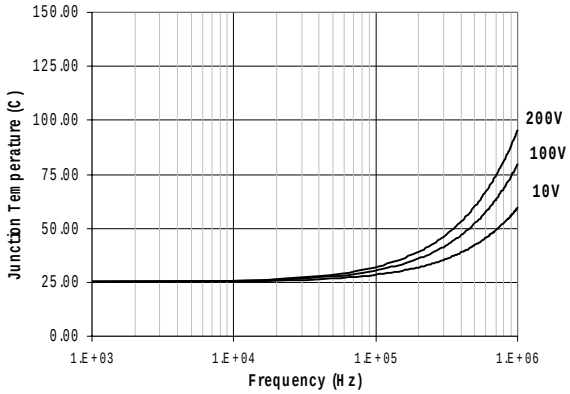


Figure 31. IR2010 Tj vs Frequency
R_{GATE} = 33 Ohm, Vcc = 15V with IRFBC20

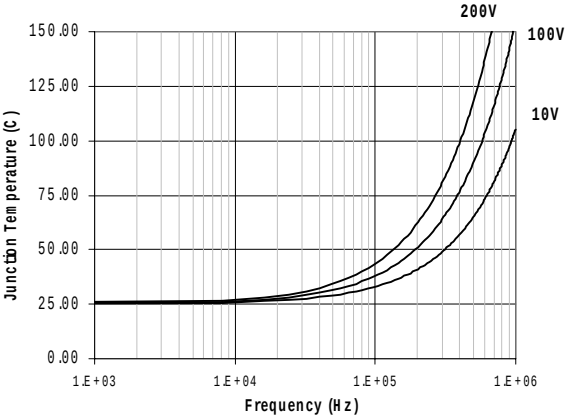


Figure 32. IR2010S Tj vs Frequency
R_{GATE} = 10 Ohm, Vcc = 15V with IRFPE50

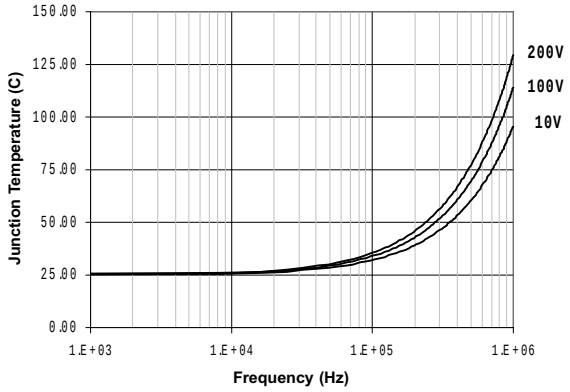


Figure 33. IR2010S Tj vs Frequency
R_{GATE} = 16 Ohm, Vcc = 15V with IRFBC40

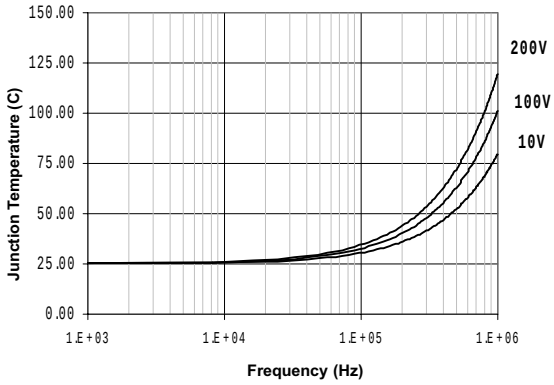


Figure 34. IR2010S Tj vs Frequency
R_{GATE} = 22 Ohm, Vcc = 15V with IRFBC30

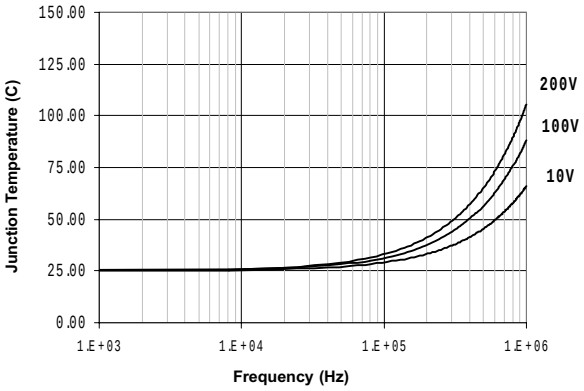
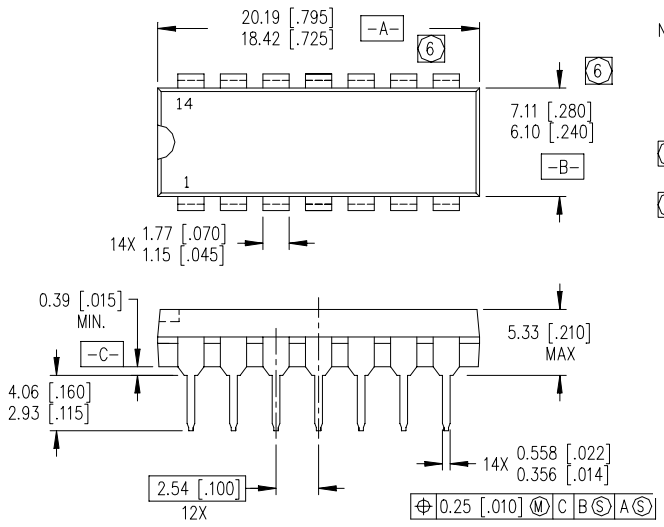
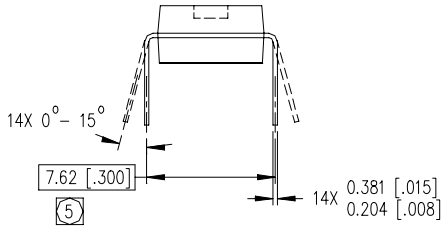


Figure 35. IR2010S Tj vs Frequency
R_{GATE} = 33 Ohm, Vcc = 15V with IRFBC20

Case Outlines

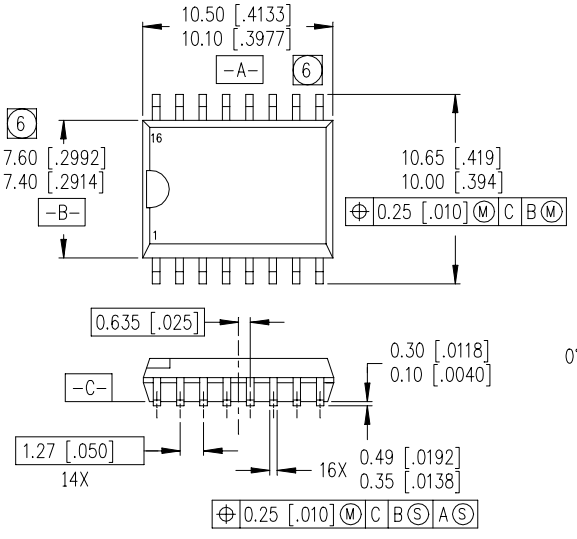


NOTES:
1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M–1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS–001AC.
5. MEASURED WITH THE LEADS CONSTRAINED TO BE PERPENDICULAR TO DATUM PLANE C.
6. DIMENSION DOES NOT INCLUDE MOLD PROTUSIONS. MOLD PROTUSIONS SHALL NOT EXCEED 0.25 [.010].

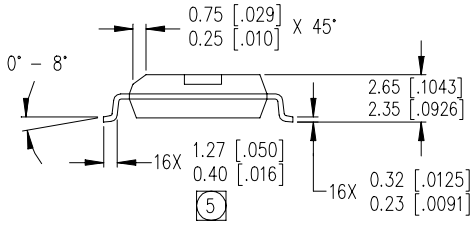


14 Lead PDIP

01-6010
01-3002 03 (MS-001AC)



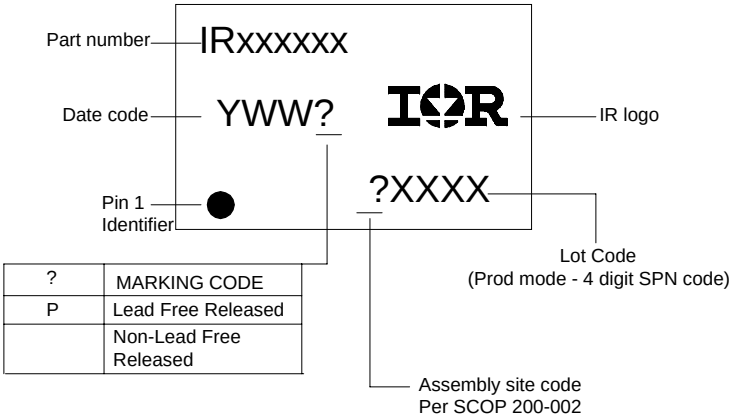
NOTES:
1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M–1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS–013AA.
5. DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.
6. DIMENSION DOES NOT INCLUDE MOLD PROTUSIONS. MOLD PROTUSIONS SHALL NOT EXCEED 0.15 [.006].



16 Lead SOIC (wide body)

01 6012
01-3014 03 (MS-013AA)

LEADFREE PART MARKING INFORMATION



?	MARKING CODE
P	Lead Free Released
	Non-Lead Free Released

ORDER INFORMATION

Basic Part (Non-Lead Free)
14-Lead PDIP IR2010 order IR2010
16-Lead SOIC IR2010S order IR2010S

Leadfree Part
14-Lead PDIP IR2010 order IR2010PbF
16-Lead SOIC IR2010S order IR2010SPbF

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245 Tel: (310) 252-7105

This product has been qualified per industrial level

Data and specifications subject to change without notice. 9/12/2004